



1M x 1 Static RAM

Features

- High speed
 - $t_{AA} = 12$ ns
- CMOS for optimum speed/power
- Low active power
 - 825 mW
- Low standby power
 - 275 mW
- 2.0V data retention (optional)
 - 100 μ W
- Automatic power-down when deselected
- TTL-compatible inputs and outputs

Functional Description

The CY7C1007 is a high-performance CMOS static RAM organized as 1,048,576 words by 1 bit. Easy memory expansion is provided by an active LOW chip enable (CE) and three-state drivers. The device has an automatic power-down feature that reduces power consumption by more than 65% when deselected.

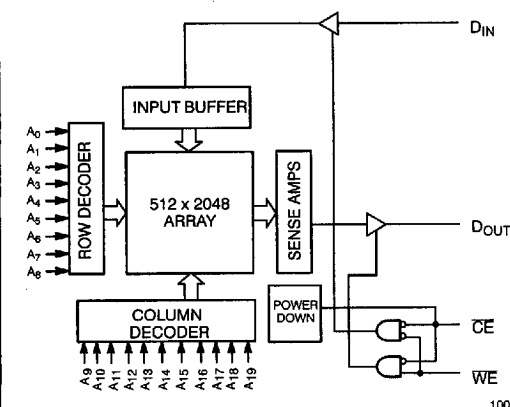
Writing to the device is accomplished by taking chip enable (CE) and write enable (WE) inputs LOW. Data on the input pin (D_{IN}) is written into the memory location specified on the address pins (A₀ through A₁₉).

Reading from the device is accomplished by taking chip enable (CE) LOW while write enable (WE) remains HIGH. Under these conditions, the contents of the memory location specified by the address pins will appear on the data output (D_{OUT}) pin.

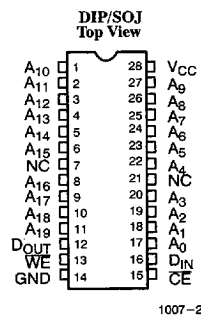
The output pin (D_{OUT}) is placed in a high-impedance state when the device is deselected (CE HIGH) or during a write operation (CE and WE LOW).

The CY7C1007 is available in standard 300-mil-wide DIPs and SOJs.

Logic Block Diagram



Pin Configuration



Selection Guide

		7C1007-12	7C1007-15	7C1007-20	7C1007-25
Maximum Access Time (ns)		12	15	20	25
Maximum Operating Current (mA)	Commercial	150	135	125	120
	Military		145	135	130
Maximum Standby Current (mA)	Commercial	50	40	30	30
	Military		40	30	30

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	-65°C to +150°C
Ambient Temperature with Power Applied	-55°C to +125°C
Supply Voltage on V _{CC} Relative to GND ^[1]	-0.5V to +7.0V
DC Voltage Applied to Outputs in High Z State ^[1]	-0.5V to V _{CC} + 0.5V
DC Input Voltage ^[1]	-0.5V to V _{CC} + 0.5V
Current into Outputs (LOW)	20 mA

Static Discharge Voltage >2001V

(per MIL-STD-883, Method 3015)

Latch-Up Current >200 mA

Operating Range

Range	Ambient Temperature ^[2]	V _{CC}
Commercial	0°C to +70°C	5V ± 10%
Military	-55°C to +125°C	5V ± 10%

Electrical Characteristics Over the Operating Range^[3]

Parameter	Description	Test Conditions	7C1007-12		7C1007-15		7C1007-20		7C1007-25		Unit
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
V _{OH}	Output HIGH Voltage	V _{CC} = Min., I _{OH} = -4.0 mA	2.4		2.4		2.4		2.4		V
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 8.0 mA		0.4		0.4		0.4		0.4	V
V _{IH}	Input HIGH Voltage		2.2	V _{CC} + 0.3	2.2	V _{CC} + 0.3	2.2	V _{CC} + 0.3	2.2	V _{CC} + 0.3	V
V _{IL}	Input LOW Voltage ^[1]		-0.3	0.8	-0.3	0.8	-0.3	0.8	-0.3	0.8	V
I _{Ix}	Input Load Current	GND ≤ V _I ≤ V _{CC}	-1	+1	-1	+1	-1	+1	-1	+1	μA
I _{OZ}	Output Leakage Current	GND ≤ V _I ≤ V _{CC} , Output Disabled	-5	+5	-5	+5	-5	+5	-5	+5	μA
I _{OS}	Output Short Circuit Current ^[4]	V _{CC} = Max., V _{OUT} = GND		-300		-300		-300		-300	mA
I _{CC}	V _{CC} Operating Supply Current	V _{CC} = Max., I _{OUT} = 0 mA, f = f _{MAX} = 1/t _{RC}	Com'l	150		135		125		120	mA
			Mil			145		135		130	
I _{SB1}	Automatic CE Power-Down Current - TTL Inputs	Max. V _{CC} , CE ≥ V _{IH} , V _{IN} ≥ V _{IH} or V _{IN} ≤ V _{IL} , f = f _{MAX}	Com'l	50		40		30		30	mA
			Mil			40		30		30	
I _{SB2}	Automatic CE Power-Down Current - CMOS Inputs	Max. V _{CC} , CE ≥ V _{CC} - 0.3V, V _{IN} ≥ V _{CC} - 0.3V or V _{IN} ≤ 0.3V, f = 0	Com'l	2		2		2		2	mA
			Mil			2		2		2	

Capacitance^[5]

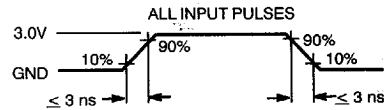
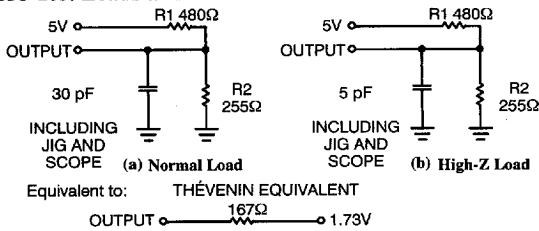
Parameter	Description	Test Conditions	Max.	Unit
C _{IN} : Addresses	Input Capacitance	T _A = 25°C, f = 1 MHz, V _{CC} = 5.0V	7	pF
C _{IN} : Controls			10	pF
C _{OUT}	Output Capacitance		10	pF

Notes:

- V_{IL} (min.) = -2.0V for pulse durations of less than 20 ns.
- T_A is the "instant on" case temperature.
- See the last page of this specification for Group A subgroup testing information.
- Not more than 1 output should be shorted at one time. Duration of the short circuit should not exceed 30 seconds.
- Tested initially and after any design or process changes that may affect these parameters.



AC Test Loads and Waveforms



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Switching Characteristics^[3, 6] Over the Operating Range

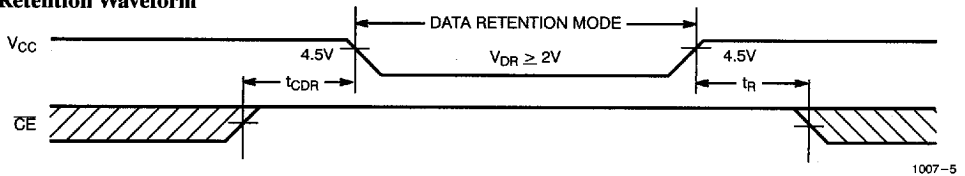
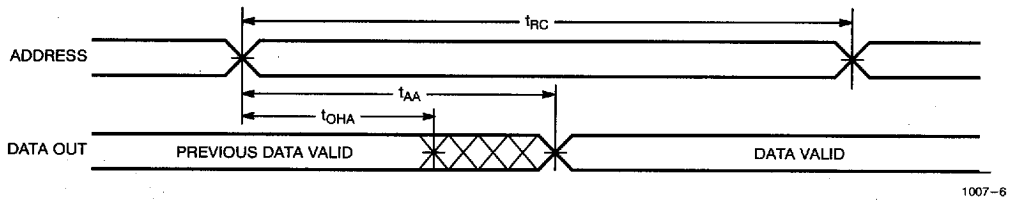
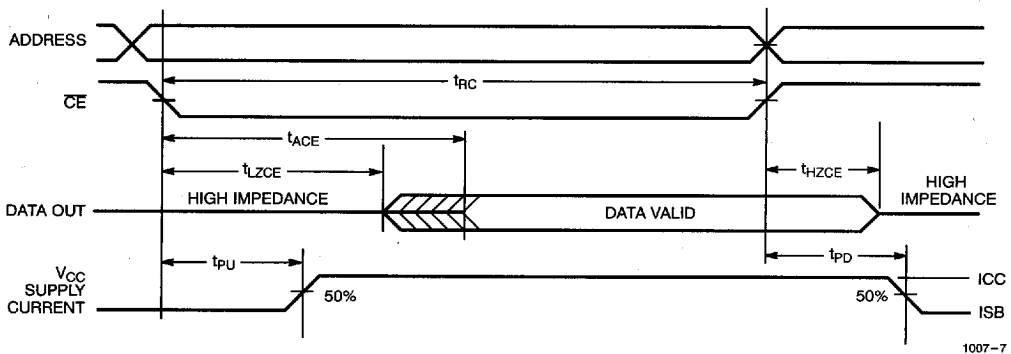
Parameter	Description	7C1007-12		7C1007-15		7C1007-20		7C1007-25		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
READ CYCLE										
t _{RC}	Read Cycle Time	12		15		20		25		ns
t _{AA}	Address to Data Valid		12		15		20		25	ns
t _{OHA}	Data Hold from Address Change	3		3		3		3		ns
t _{ACE}	$\overline{CE}$ LOW to Data Valid		12		15		20		25	ns
t _{LZCE}	$\overline{CE}$ LOW to Low Z ^[7]	3		3		3		3		ns
t _{HZCE}	$\overline{CE}$ HIGH to High Z ^[7, 8]		6		7		8		10	ns
t _{PU}	$\overline{CE}$ LOW to Power-Up	0		0		0		0		ns
t _{PD}	$\overline{CE}$ HIGH to Power-Down		12		15		20		25	ns
WRITE CYCLE ^[9]										
t _{WC}	Write Cycle Time	12		15		20		25		ns
t _{SCE}	$\overline{CE}$ LOW to Write End	10		12		15		20		ns
t _{AW}	Address Set-Up to Write End	10		12		15		20		ns
t _{HA}	Address Hold from Write End	0		0		0		0		ns
t _{SA}	Address Set-Up to Write Start	0		0		0		0		ns
t _{PWE}	WE Pulse Width	10		12		15		20		ns
t _{SD}	Data Set-Up to Write End	7		8		10		15		ns
t _{HD}	Data Hold from Write End	0		0		0		0		ns
t _{LZWE}	WE HIGH to Low Z ^[7]	3		3		3		3		ns
t _{HZWE}	WE LOW to High Z ^[7, 8]		6		7		8		10	ns

Notes:

- Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified I_{OL}/I_{OH} and 30-pF load capacitance.
- At any given temperature and voltage condition, t_{HZCE} is less than t_{LZCE} and t_{HZWE} is less than t_{LZWE} for any given device.
- t_{HZCE} and t_{HZWE} are specified with a load capacitance of 5 pF as in part (b) of AC Test Loads. Transition is measured ± 500 mV from steady-state voltage.
- The internal write time of the memory is defined by the overlap of $\overline{CE}$ LOW and WE LOW. $\overline{CE}$ and WE must be LOW to initiate a write, and the transition of any of these signals can terminate the write. The input data set-up and hold timing should be referenced to the leading edge of the signal that terminates the write.

Data Retention Characteristics Over the Operating Range (L Version Only)

Parameter	Description	Conditions ^[10]	Commercial		Military		Unit
			Min.	Max.	Min.	Max.	
V_{DR}	V_{CC} for Data Retention		2.0		2.0		V
I_{CCDR}	Data Retention Current	$V_{CC} = V_{DR} = 2.0V$, $CE \geq V_{CC} - 0.3V$, $V_{IN} \geq V_{CC} - 0.3V$ or $V_{IN} \leq 0.3V$		50		70	μA
$t_{CDR}^{[5]}$	Chip Deselect to Data Retention Time		0		0		ns
$t_R^{[5]}$	Operation Recovery Time		t_{RC}		t_{RC}		ns

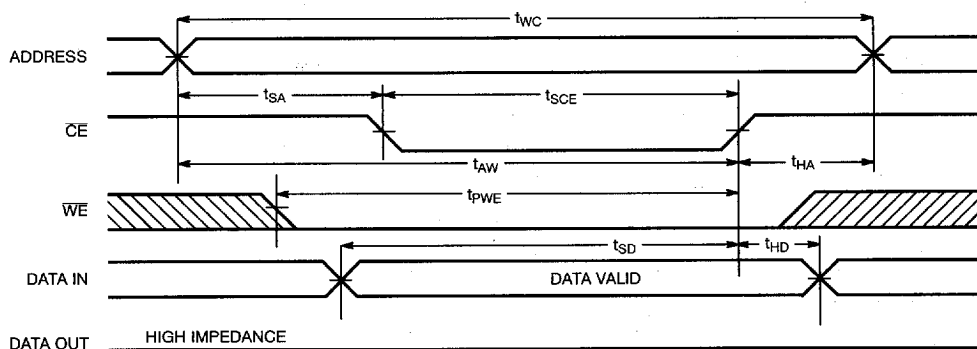
Data Retention Waveform

Switching Waveforms
Read Cycle No. 1^[11, 12]

Read Cycle No. 2^[12, 13]

Notes:

10. No input may exceed $V_{CC} + 0.5V$.
 11. Device is continuously selected, $CE = V_{IL}$.

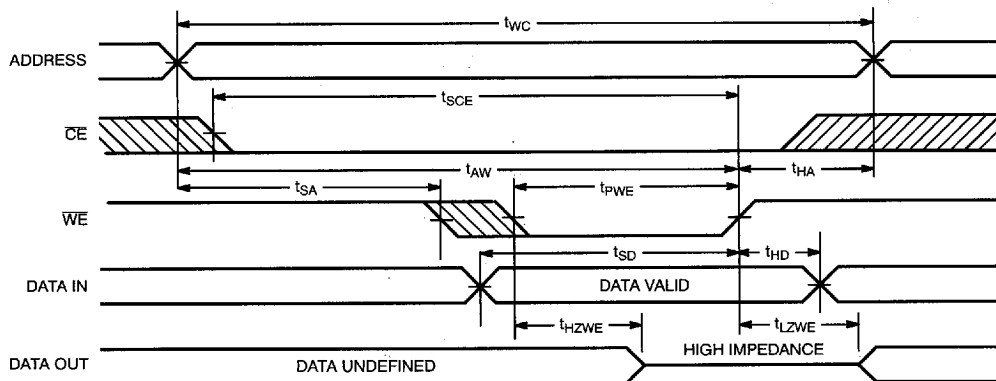
12. WE is HIGH for read cycle.
 13. Address valid prior to or coincident with CE transition LOW.



Switching Waveforms (continued)

Write Cycle No. 1 ($\overline{\text{CE}}$ Controlled)^[14]

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Write Cycle No. 2 ($\overline{\text{WE}}$ Controlled)^[14]

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Note:

14. If $\overline{\text{CE}}$ goes HIGH simultaneously with $\overline{\text{WE}}$ going HIGH, the output remains in a high-impedance state.

Truth Table

$\overline{\text{CE}}$	$\overline{\text{WE}}$	D _{OUT}	Mode	Power
H	X	High Z	Power-Down	Standby (I_{SB})
L	H	Data Out	Read	Active (I_{CC})
L	L	High Z	Write	Active (I_{CC})

Ordering Information

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
12	CY7C1007-12PC	P21	28-Lead (300-Mil) Molded DIP	Commercial
	CY7C1007-12VC	V21	28-Lead (300-Mil) Molded SOJ	
15	CY7C1007-15PC	P21	28-Lead (300-Mil) Molded DIP	Commercial
	CY7C1007-15VC	V21	28-Lead (300-Mil) Molded SOJ	
	CY7C1007-15DMB	D22	28-Lead (300-Mil) CerDIP	Military
20	CY7C1007-20PC	P21	28-Lead (300-Mil) Molded DIP	Commercial
	CY7C1007-20VC	V21	28-Lead (300-Mil) Molded SOJ	
	CY7C1007-20DMB	D22	28-Lead (300-Mil) CerDIP	Military
25	CY7C1007-25PC	P21	28-Lead (300-Mil) Molded DIP	Commercial
	CY7C1007-25VC	V21	28-Lead (300-Mil) Molded SOJ	
	CY7C1007-25DMB	D22	28-Lead (300-Mil) CerDIP	Military

Contact factory for "L" version availability.

MILITARY SPECIFICATIONS
Group A Subgroup Testing
DC Characteristics

Parameter	Subgroups
V_{OH}	1, 2, 3
V_{OL}	1, 2, 3
V_{IH}	1, 2, 3
V_{IL} Max.	1, 2, 3
I_{IX}	1, 2, 3
I_{OZ}	1, 2, 3
I_{CC}	1, 2, 3
I_{SB1}	1, 2, 3
I_{SB2}	1, 2, 3

Document #: 38-00198-B

Switching Characteristics

Parameter	Subgroups
READ CYCLE	
t_{RC}	7, 8, 9, 10, 11
t_{AA}	7, 8, 9, 10, 11
t_{OHA}	7, 8, 9, 10, 11
t_{ACE}	7, 8, 9, 10, 11
WRITE CYCLE	
t_{WC}	7, 8, 9, 10, 11
t_{SCE}	7, 8, 9, 10, 11
t_{AW}	7, 8, 9, 10, 11
t_{HA}	7, 8, 9, 10, 11
t_{SA}	7, 8, 9, 10, 11
t_{PWE}	7, 8, 9, 10, 11
t_{SD}	7, 8, 9, 10, 11
t_{HD}	7, 8, 9, 10, 11